# 74HC393; 74HCT393

### **Dual 4-bit binary ripple counter**

Rev. 8 — 22 October 2021

**Product data sheet** 

### 1. General description

The 74HC393; 74HCT393 is a dual 4-stage binary ripple counter. Each counter features a clock input ( $\overline{nCP}$ ), an overriding asynchronous master reset input ( $\overline{nMR}$ ) and 4 buffered parallel outputs ( $\overline{nQ0}$  to  $\overline{nQ3}$ ). The counter advances on the HIGH-to-LOW transition of  $\overline{nCP}$ . A HIGH on  $\overline{nMR}$  clears the counter stages and forces the outputs LOW, independent of the state of  $\overline{nCP}$ . Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

#### 2. Features and benefits

- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- · High noise immunity
- · Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- · Complies with JEDEC standards:
  - JESD8C (2.7 V to 3.6 V)
  - JESD7A (2.0 V to 6.0 V)
- Input levels:
  - For 74HC393: CMOS level
  - For 74HCT393: TTL level
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V.
- Two 4-bit binary counters with individual clocks
- Divide by any binary module up to 28 in one package
- · Two master resets to clear each 4-bit counter individually

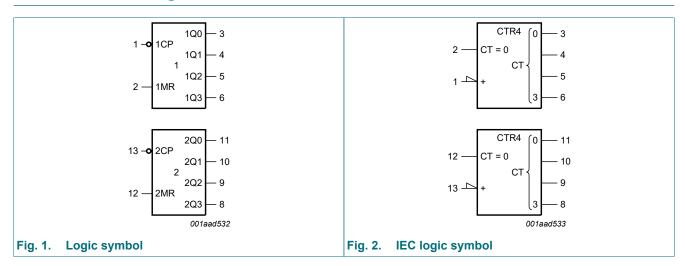
### 3. Ordering information

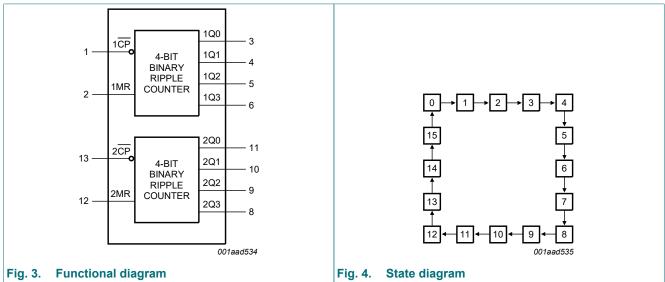
Table 1. Ordering information

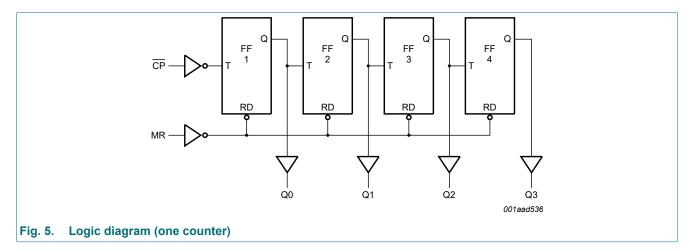
Type number	Package								
	Temperature range	Name	Description	Version					
74HC393D	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads;	SOT108-1					
74HCT393D			body width 3.9 mm						
74HC393PW	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads;	SOT402-1					
74HCT393PW			body width 4.4 mm						
74HC393BQ	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced	SOT762-1					
74HCT393BQ			very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm						



### 4. Functional diagram

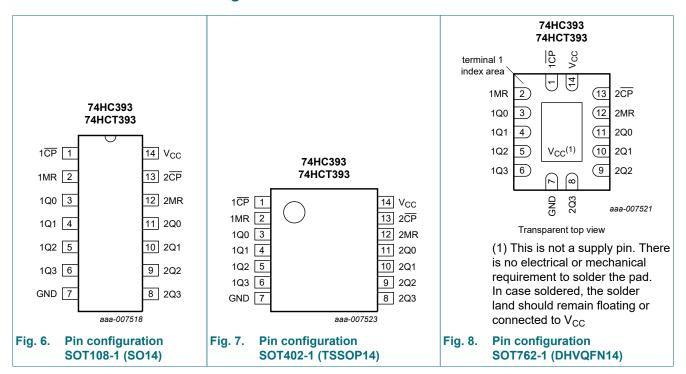






### 5. Pinning information

#### 5.1. Pinning



#### 5.2. Pin description

Table 2. Pin description

Table 2. Fill description							
Symbol	Pin	Description					
1 <del>CP</del>	1	clock input (HIGH-to-LOW, edge-triggered)					
1MR	2	asynchronous master reset input (active HIGH)					
1Q0, 1Q1, 1Q2, 1Q3	3, 4, 5, 6	flip-flop output					
GND	7	ground (0 V)					
2Q3, 2Q2, 2Q1, 2Q0	8, 9, 10, 11	flip-flop output					
2MR	12	asynchronous master reset input (active HIGH)					
2 <del>CP</del>	13	clock input (HIGH-to-LOW, edge-triggered)					
V <sub>CC</sub>	14	supply voltage					

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### 6. Functional description

#### Table 3. Count sequence for one counter

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level.$ 

Count	Output			
	nQ0	nQ1	nQ2	nQ3
0	L	L	L	L
1	Н	L	L	L
2	L	Н	L	L
3	Н	Н	L	L
4	L	L	Н	L
5	Н	L	Н	L
6	L	Н	Н	L
7	Н	Н	Н	L
8	L	L	L	Н
9	Н	L	L	Н
10	L	Н	L	Н
11	Н	Н	L	Н
12	L	L	Н	Н
13	Н	L	Н	Н
14	L	Н	Н	Н
15	Н	Н	Н	Н

### 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
Io	output current	$V_{O} = -0.5 \text{ V to } V_{CC} + 0.5 \text{ V}$	-	±25	mA
I <sub>CC</sub>	supply current		-	±50	mA
I <sub>GND</sub>	ground current		-	±50	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	[1]	-	500	mW

<sup>[1]</sup> For SOT108-1 (SO14) package:  $P_{tot}$  derates linearly with 10.1 mW/K above 100 °C.

For SOT402-1 (TSSOP14) package:  $P_{tot}$  derates linearly with 7.3 mW/K above 81 °C.

For SOT762-1 (DHVQFN14) package:  $P_{tot}$  derates linearly with 9.6 mW/K above 98  $^{\circ}\text{C}.$ 

### 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Parameter Conditions 74HC393		7	Unit				
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V

### 9. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C			°C to 5 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC39	3									
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
	V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V	
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$								
	output voltage	I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O}$ = -4.0 mA; $V_{CC}$ = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O}$ = -5.2 mA; $V_{CC}$ = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		$I_O = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
C <sub>I</sub>	input capacitance		-	3.5	-	-	-	-	-	pF

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
<b>74HCT3</b>	93									•
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	V <sub>OH</sub> HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
		I <sub>O</sub> = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -4 mA	3.98	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
	output voltage	Ι <sub>Ο</sub> = 20 μΑ	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
ΔI <sub>CC</sub>	additional supply current	$V_1 = V_{CC} - 2.1 \text{ V};$ other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $I_O = 0 \text{ A}$								
		per input pin; nCP	-	40	144	-	180	-	196	μΑ
		per input pin; nMR	-	100	360	-	450	-	490	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

### 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); C<sub>L</sub> = 50 pF unless otherwise specified; for test circuit see Fig. 11.

Symbol	Parameter	Conditions		25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC393	3		•						•	
t <sub>pd</sub>	propagation	nCP to nQ0; see Fig. 9	]							
	delay	V <sub>CC</sub> = 2.0 V	-	41	125	-	155	-	190	ns
		V <sub>CC</sub> = 4.5 V	-	15	25	-	31	-	38	ns
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$	-	12	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	12	21	-	26	-	32	ns
		nQx to nQ(x+1); see Fig. 9	]							
		V <sub>CC</sub> = 2.0 V	-	14	45	-	55	-	70	ns
		V <sub>CC</sub> = 4.5 V	-	5	9	-	11	-	14	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	5	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	4	8	-	9	-	12	ns

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t <sub>PHL</sub>	HIGH to LOW	nMR to nQx; see Fig. 10								
	propagation delay	V <sub>CC</sub> = 2.0 V	-	39	140	-	175	-	210	ns
	uelay	V <sub>CC</sub> = 4.5 V	-	14	28	-	35	-	42	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	11	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	11	24	-	30	-	36	ns
t <sub>t</sub>	transition time	Qn; see Fig. 9 [2]								
		V <sub>CC</sub> = 2.0 V	-	19	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	16	-	19	ns
t <sub>W</sub>	pulse width	nCP HIGH or LOW; see Fig. 9								
		V <sub>CC</sub> = 2.0 V	80	17	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	6	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	5	-	17	-	20	-	ns
		nMR HIGH; see Fig. 10								
		V <sub>CC</sub> = 2.0 V	80	19	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	7	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	6	-	17	-	20	-	ns
t <sub>rec</sub> recovery tim	recovery time	nMR to nCP; see Fig. 10								
		V <sub>CC</sub> = 2.0 V	5	3	-	5	-	5	-	ns
		V <sub>CC</sub> = 4.5 V	5	1	-	5	-	5	-	ns
		V <sub>CC</sub> = 6.0 V	5	1	-	5	-	5	-	ns
f <sub>clk(max)</sub>	maximum	see Fig. 9								
	clock	V <sub>CC</sub> = 2.0 V	6	30	-	5	-	4	-	MHz
	frequency	V <sub>CC</sub> = 4.5 V	30	90	-	24	-	20	-	MHz
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	99	-	-	-	-	-	MHz
		V <sub>CC</sub> = 6.0 V	35	107	-	28		24	-	MHz
C <sub>PD</sub>	power dissipation capacitance	$C_L$ = 50 pF; f = 1 MHz; [3] $V_I$ = GND to $V_{CC}$	-	23	-	-	-	-	-	pF
<b>74HCT3</b>	93			l						1
t <sub>pd</sub>	propagation	nCP to nQ0; see Fig. 9 [1]								
•	delay	V <sub>CC</sub> = 4.5 V	-	15	25	-	31	-	38	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	20	-	-	-	-	-	ns
		nQx to nQ(x+1); see Fig. 9 [1]								
		V <sub>CC</sub> = 4.5 V	-	6	10	-	13	-	15	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	6	-	-	-	-	-	ns
t <sub>PHL</sub>	HIGH to LOW	nMR to nQx; see Fig. 10								
	propagation	V <sub>CC</sub> = 4.5 V	-	18	32	-	40	-	48	ns
	delay	V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	15	-	-	-	-	-	ns
t <sub>t</sub>	transition time	Qn; see <u>Fig. 9</u> [2]								
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns

Symbol	Parameter	Conditions	25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit	
			Min	Тур	Max	Min	Max	Min	Max	
t <sub>W</sub>	pulse width	nCP HIGH or LOW; see Fig. 9								
		V <sub>CC</sub> = 4.5 V	19	11	-	24	-	29	-	ns
		nMR HIGH; see Fig. 10								
		V <sub>CC</sub> = 4.5 V	16	6	-	20	-	24	-	ns
t <sub>rec</sub>	recovery time	nMR to nCP; see Fig. 10								
		V <sub>CC</sub> = 4.5 V	5	0	-	5	-	5	-	ns
f <sub>clk(max)</sub>	maximum	see Fig. 9								
	clock frequency	V <sub>CC</sub> = 4.5 V	27	48	-	22	-	18	-	MHz
	licquericy	V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	53	-	-	-	-	-	MHz
C <sub>PD</sub>	power dissipation capacitance	$C_L = 50 \text{ pF; } f = 1 \text{ MHz;}$ [3] $V_I = \text{GND to } V_{CC} - 1.5 \text{ V}$	-	25	-	-	-	-	-	pF

- $t_{\text{pd}}$  is the same as  $t_{\text{PLH}}$  and  $t_{\text{PHL}}$ .
- $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$$
 where:

f<sub>i</sub> = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

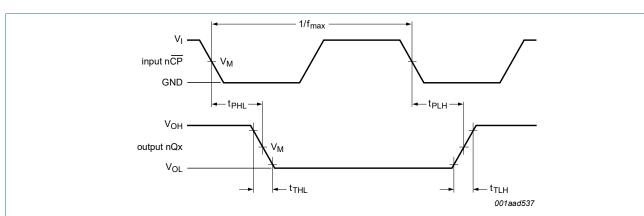
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$ 

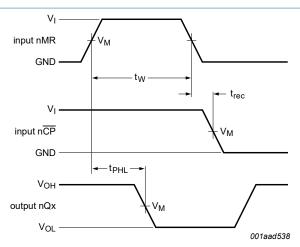
#### 10.1. Waveforms



Measurement points are given in Table 8.

 $V_{OL}$  and  $V_{OH}$  are the typical output voltage levels that occur with the output load.

Propagation delays clock (nCP) to output (nQx), the output transition times and the maximum clock Fig. 9. frequency



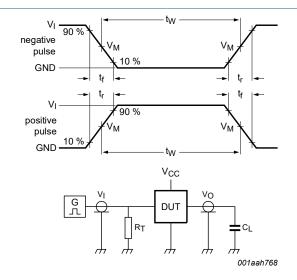
Measurement points are given in <u>Table 8</u>.

V<sub>OL</sub> and V<sub>OH</sub> are the typical output voltage levels that occur with the output load.

Fig. 10. Propagation delays clock (nCP) to output (nQx), pulse width master reset (nMR), and recovery time master reset (nMR) to clock (nCP)

**Table 8. Measurement points** 

Туре	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
74HC393	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
74HCT393	1.3 V	1.3 V



Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

 $C_L$  = load capacitance including jig and probe capacitance.

Fig. 11. Test circuit for measuring switching times

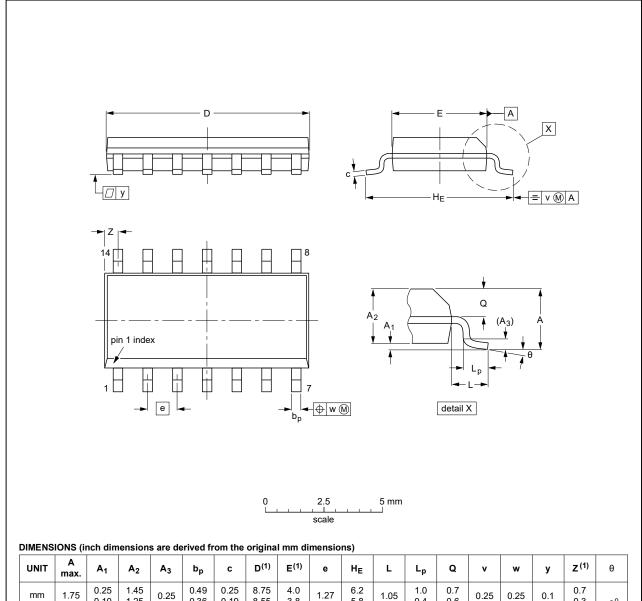
Table 9. Test data

Туре	Input L		Load	Test
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	
74HC393	V <sub>CC</sub>	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>
74HCT393	3.0 V	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>

### 11. Package outline

#### SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



u	JNIT	A max.	<b>A</b> <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	V	w	у	Z <sup>(1)</sup>	θ
	mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
in	ches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

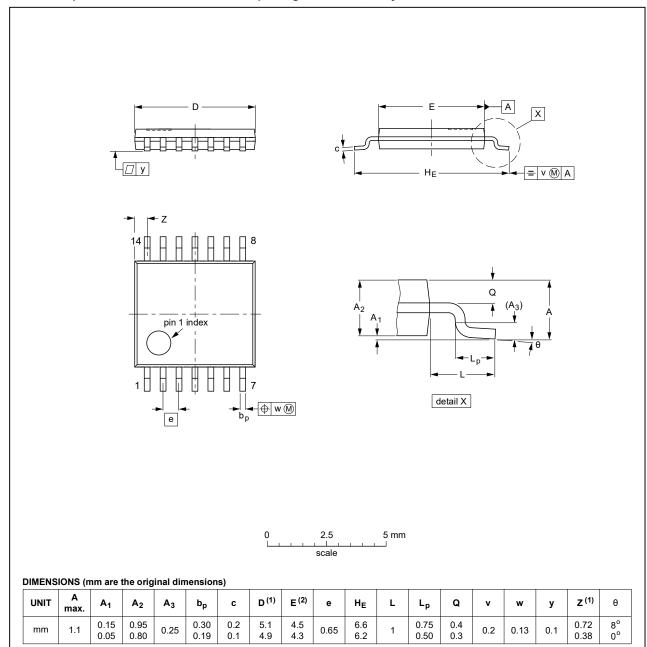
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012				<del>99-12-27</del> 03-02-19

Fig. 12. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT402-1		MO-153				<del>99-12-27</del> 03-02-18

Fig. 13. Package outline SOT402-1 (TSSOP14)

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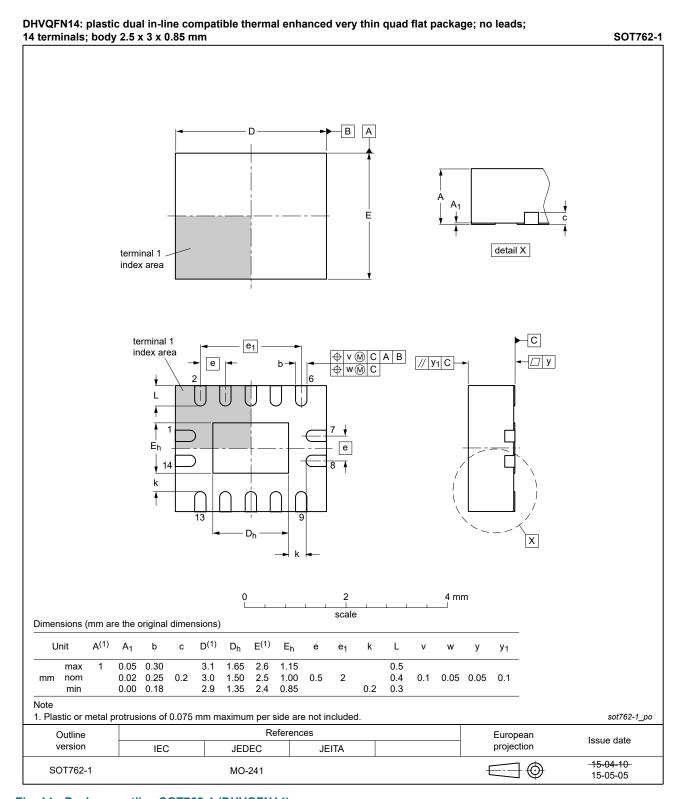


Fig. 14. Package outline SOT762-1 (DHVQFN14)

### 12. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model

### 13. Revision history

#### **Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT393 v.8	20211022	Product data sheet	-	74HC_HCT393 v.7.1
Modifications:	• <u>Table 6</u> : V <sub>OI</sub>	and V <sub>OL</sub> conditions for 74	HCT393 correcte	d. (Errata)
74HC_HCT393 v.7.1	20201021	Product data sheet	-	74HC_HCT393 v.6
Modifications:	Nexperia. Legal texts I Type numbe Section 1 (E Table 4: Der	nave been adapted to the reers 74HC393DB and 74HC errata) and <u>Section 2</u> updaterating values for P <sub>tot</sub> total p	new company nan T393DB (SOT337 ed. ower dissipation u	7-1/SSOP14) removed.
74HC_HCT393 v.6	20151203	Product data sheet	-	74HC_HCT393 v.5
Modifications:	Type number	ers 74HC393N and 74HCT	393N (SOT27-1)	removed.
74HC_HCT393 v.5	20140401	Product data sheet	-	74HC_HCT393 v.4
Modifications:	• Table 7: The	conditions for C <sub>PD</sub> have b	een corrected (er	rata).
74HC_HCT393 v.4	20130516	Product data sheet	-	74HC_HCT393 v.3
Modifications:	guidelines o	of this data sheet has been f NXP Semiconductors. nave been adapted to the r	_	
74HC_HCT393 v.3	20050906	Product data sheet	-	74HC_HCT393_CNV v.2
74HC_HCT393_CNV v.2	19901201	Product specification	-	-

### 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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